GR 97 P 2681

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant

Albrecht Mayer

Appl. No

09/164,123

Filed

Title

September 30, 1998

Method for Assembling Integrated Circuits With Protection Of The Circuits Against Electrostatic Discharge, And Arragement Of Integrated Circuits With Protection Against

Electrostatic Discharge

Examiner

Kurt M. Eaton

Group Art Unit :

## AMENDMENT

Hon. Commissioner of Patents and Trademarks, Washington, D. C. 20231

2823

Sir:

Responsive to the Office action dated April 13, 2000 kindly amend the above-identified application as follows:

Please change the title to:

-- METHOD FOR ASSEMBLING INTEGRATED CIRCUITS WITH PROTECTION OF THE CIRCUITS AGAINST ELECTROSTATIC DISCHARGE --